- 21. (Added) The method of claim 20, wherein the plurality of abrasive particles has a hardness comparable to the hardness of the low dielectric constant surface.
- 22. (Added) The method of claim 20, wherein the plurality of abrasive particles has a surface charge opposite to that of the low dielectric constant surface.
- 23. (Added) The method of claim 21, wherein the plurality of abrasive particles has a surface charge opposite to that of the low dielectric constant surface.
- 24. (Added) The method of claim 20, wherein the core material comprises polystyrene-acrylonitrile, Nylon-6, polyoxymethylene, polyurethane and poly(para-divinylphenylene) or mixtures thereof.
- 25. (Added) The method of claim 20, wherein the coating material is softer than the core material.
- 26. (Added) A method of planarizing a low dielectric constant surface, comprising: performing a conventional chemical mechanical planarization; and
 - buffing with an abrasive slurry wherein the abrasive slurry comprises a plurality of core particles, wherein each core particle comprises a surface and at least one core particle at least one core material; and a coating material that coats the surface of the plurality of core particles, wherein the core particles and the coating material form a plurality of abrasive particles and wherein the density of the coating material is less than the density of the core material.
- 27. (Added) The method of claim 26, wherein the plurality of abrasive particles has a hardness comparable to the hardness of the low dielectric constant surface.
- 28. (Added) The method of claim 26, wherein the plurality of abrasive particles has a surface charge opposite to that of the low dielectric constant surface.
- 29. (Added) The method of claim 27, wherein the plurality of abrasive particles has a surface charge opposite to that of the low dielectric constant surface.